Silicon P Channel MOS FET High Speed Power Switching



ADE-208-519 1st. Edition

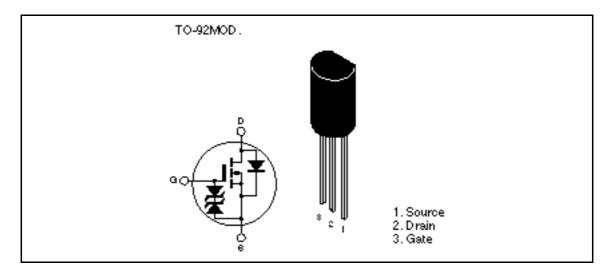
#### Features

Low on-resistance

 $R_{\text{DS(on)}} = 0.08 \quad typ \; (at \; V_{\text{GS}} = -10 \; V, \, I_{\text{D}} = -2.5 \; A)$ 

- 4V gate drive devices.
- Large current capacitance  $I_D = -5 A$

#### Outline





# **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	-30	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	-5	А	
Drain peak current	Note1 D(pulse)	-20	А	
Body to drain diode reverse drain current	I <sub>DR</sub>	-5	А	
Channel dissipation	Pch	0.9	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

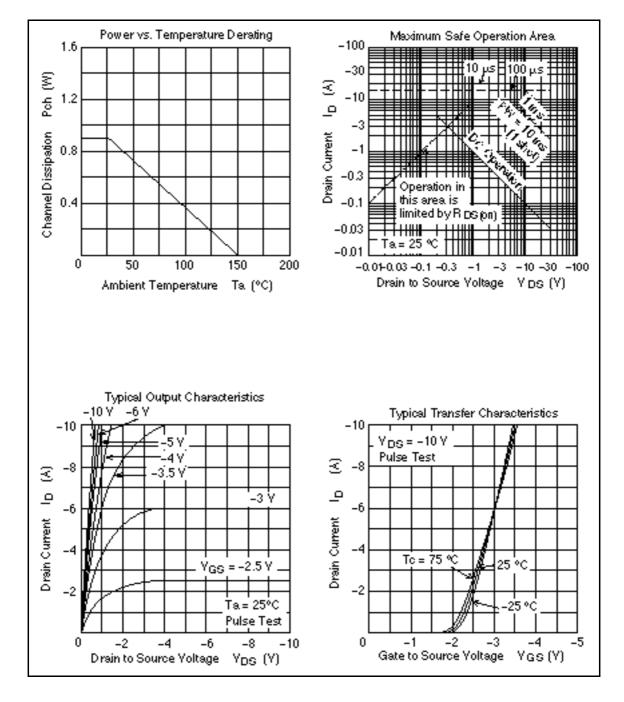
Note: 1. PW 10µs, duty cycle 1 %

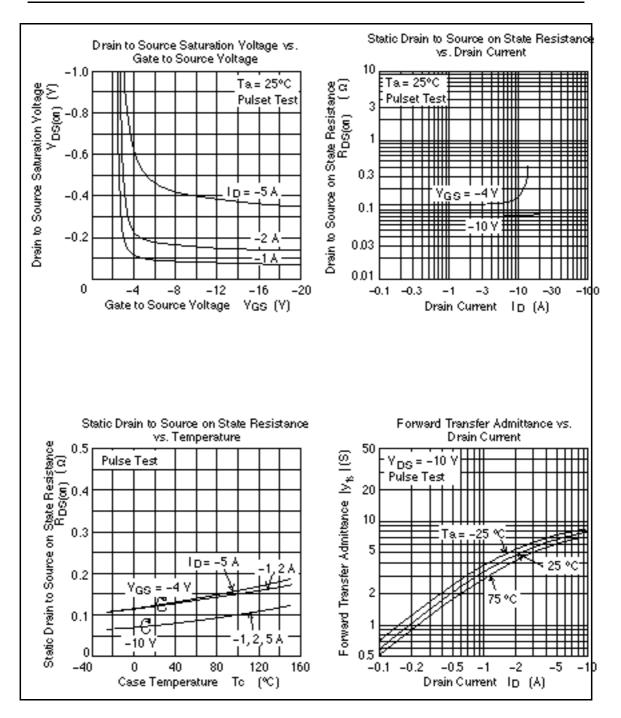
# **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

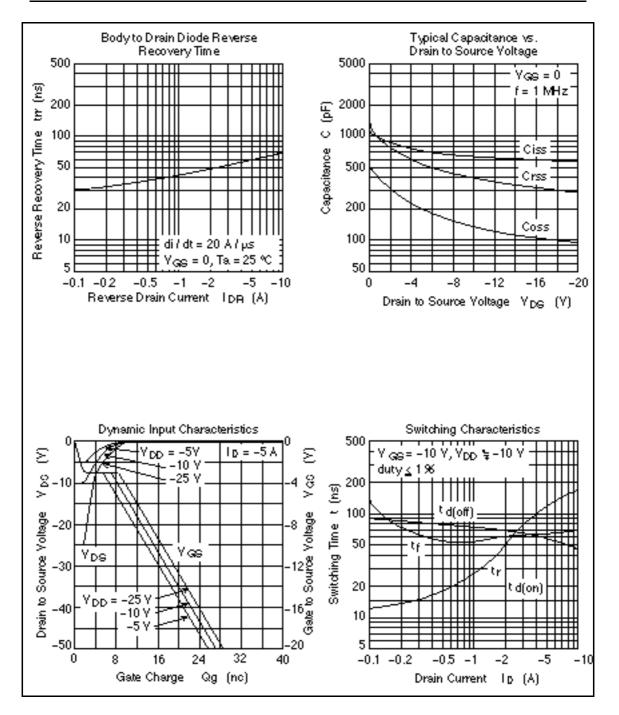
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	-30	_	_	V	$I_{\rm D} = -10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	-10	μA	$V_{\rm DS} = -30$ V, $V_{\rm GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	-1.0	_	-2.0	V	$I_{D} = -1mA, V_{DS} = -10V$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	—	0.08	0.11		$I_{\rm D} = -2.5 {\rm A}$ $V_{\rm GS} = -10 {\rm V}^{*1}$
	$R_{DS(on)}$	—	0.12	0.17		$I_{D} = -2.5A$ $V_{GS} = -4V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	3	5	—	S	$I_{\rm D} = -2.5A,$ $V_{\rm DS} = -10V^{*1}$
Input capacitance	Ciss		630	_	pF	$V_{DS} = -10V$
Output capacitance	Coss	_	390	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	135	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	15	_	ns	$V_{GS} = -10V, I_{D} = -2.5A$
Rise time	t,	_	70	_	ns	$R_{L} = 4$
Turn-off delay time	t <sub>d(off)</sub>	_	65	_	ns	_
Fall time	t <sub>f</sub>	_	60	_	ns	
Body to drain diode forward voltage	$V_{\text{DF}}$	_	-1.0	_	V	$I_{\rm D} = -5A, V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	60		ns	$I_F = -5A$ , $V_{GS} = 0$ diF/ dt = 20A/µs
Noto: 1 Dulas test						

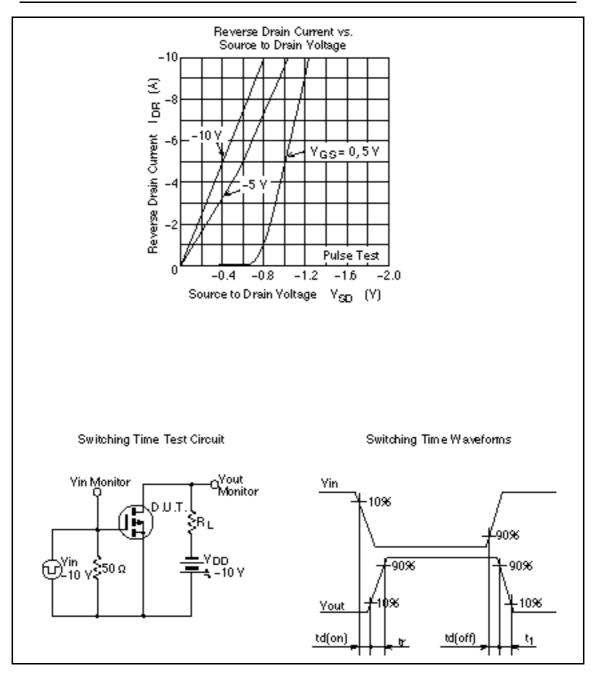
Note: 1. Pulse test

#### **Main Characteristics**



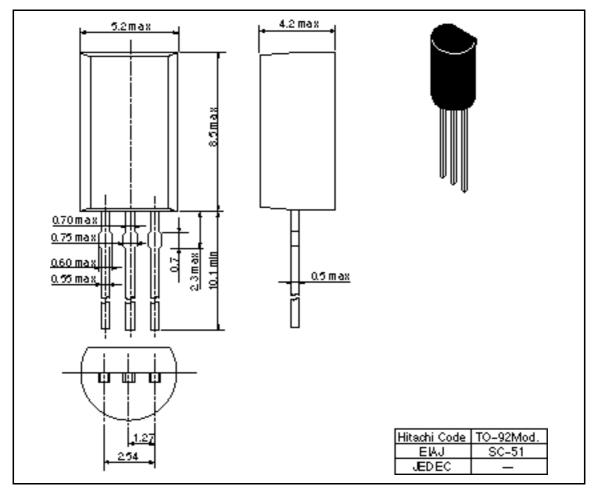






# **Package Dimensions**





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